

Product Data Sheet Type: PR31/63/SE

Group: HEATSINKS Board Level

For single mounting

Width :	35 mm
Height :	25.4 mm
Length :	63 mm
Minimum thermal resistance :	4,7 K/W
For device :	TO 220 TO 218 TOP 3
Device mounted by :	Screw
Heatsink mounted by :	Solder
Surface :	Black Anodised
Material :	AlMgSi0,5



- Special extruded heatsink for semiconductor case TO220, TO218(TOP3)
- Aluminium, anodised black, solderable
- Standard heights: 38, 50 and 63 mm
- 1 x 3.2 mm holes for semiconductor assembly
- Heatsink solderable by tin plated solder pins

